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2SD1559

Silicon NPN Triple Diffused

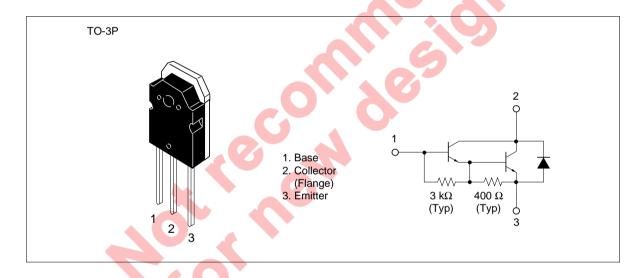


ADE-208-914 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier complementary pair with 2SB1079

Outline



2SD1559

Absolute Maximum Ratings (Ta = 25°C)

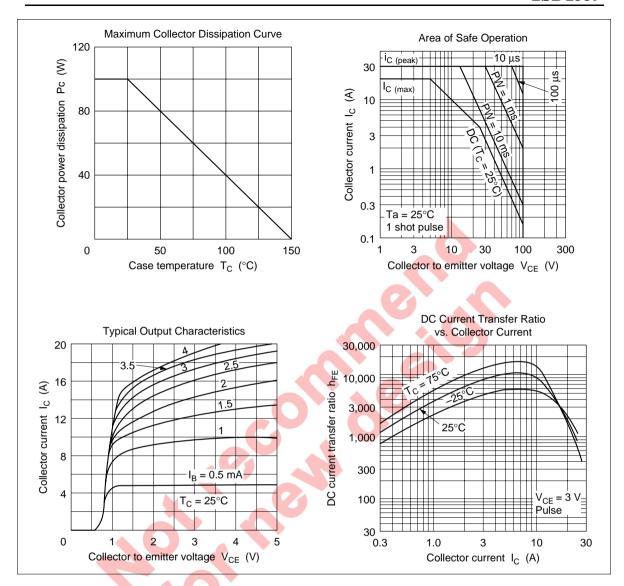
Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	100	V
Collector to emitter voltage	V_{CEO}	100	V
Emitter to base voltage	V_{EBO}	7	V
Collector current	I _c	20	А
Collector peak current	I _{C(peak)}	30	А
Base current	I _B	3	А
Collector power dissipation	P _c *1	100	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

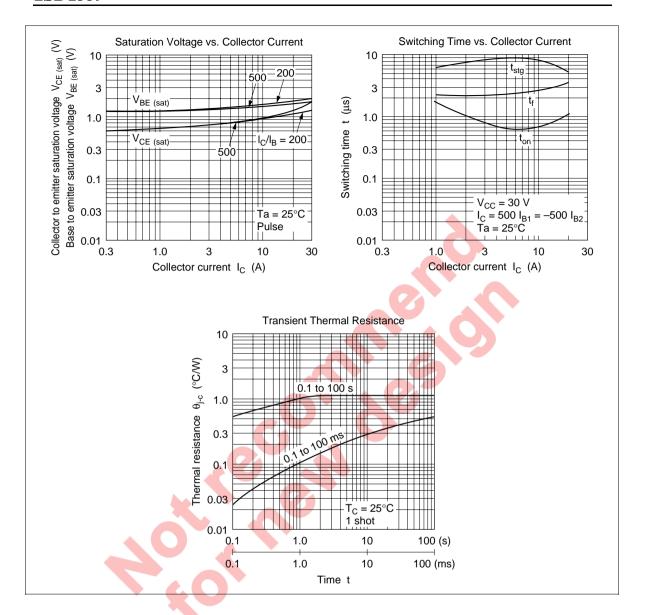
Note: 1. Value at $T_c = 25^{\circ}C$.

Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	100		-	V	$I_{\rm C} = 0.1 \text{ mA}, I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	100	_	0	V	$I_{\rm C}$ = 25 mA, $R_{\rm BE}$ = ∞
Collector to emitter sustain voltage	$V_{\text{CEO(sus)}}$	100	N	_	V	$I_{\rm C} = 200 \text{ mA}, R_{\rm BE} = \infty^{*1}$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7		_	V	$V_{EB} = 50 \text{ mA}, I_{C} = 0$
Collector cutoff current	I _{CBO}		_	100	μΑ	$V_{CB} = 100 \text{ V}, I_{E} = 0$
	I _{CEO}		_	1.0	mA	V _{CE} = 80 V, R _{BE} = ∞
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{CE} = 3 \text{ V}, I_{C} = 10 \text{ A}^{*1}$
Collector to emitter saturation voltage	V _{CE(sat)1}	_	_	2.0	V	I _C = 10 A, I _B = 20 mA* ¹
Base to emitter saturatiopn voltage	V _{BE(sat)1}	_	_	2.5	V	_
Collector to emitter saturation voltage	$V_{CE(sat)2}$	_	_	3.0	V	$I_{\rm C} = 20 \text{ A}, I_{\rm B} = 200 \text{ mA*}^{1}$
Base to emitter saturation voltage	$V_{BE(sat)2}$	_	_	3.5	V	
Turn on time	t _{on}	_	1.0	_	μs	$I_{\rm C} = 10 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 20 \text{ mA}$
Storage time	\mathbf{t}_{stg}	_	9.0	_	μs	_
Fall time	t _f	_	3.0	_	μs	

Note: 1. Pulse test.





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